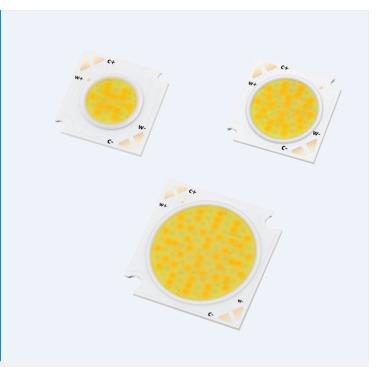
CCT Tunable LED Series Chip on Board

COB T-Series Tunable COB Data Sheet



High efficacy COB LED package well-suited for use in spotlight applications





Features & Benefits

- Chip on Board (COB) solution makes it easy to design in
- · Simple assembly reduces manufacturing cost
- Low thermal resistance
- InGaN/GaN MQW LED with long time reliability

Applications

- Spotlight / Downlight
- LED Retrofit Bulbs
- Outdoor Illumination

Table of Contents

1.	Characteristics	 3
2.	Product Code Information	 5
3.	Typical Characteristics Graphs	 8
4.	Outline Drawing & Dimension	 11
5.	Reliability Test Items & Conditions	 13
6.	Label Structure	 14
7.	Packing Structure	 15
8.	Precautions in Handling & Use	 17

1. Characteristics

a) Absolute Maximum Rating

ltem	Symbol	Model	Rating	Unit	Condition
Ambient / Operating Temperature	Ta	All model	-40 ~ + 85	°C	-
Storage Temperature	T_{stg}	All model	-40 ~ +105	°C	-
LED Junction Temperature	TJ	All model	130	°C	-
Case Temperature	Tc	All model	105	°C	
		LC010T	400		-
Forward Current	I _F	LC020T	800	mA	
		LC035T	1250		
		LC010T	15		-
Power Dissipation	P_D	LC020T	30	W	
		LC035T	45		-

b) Electro-optical Characteristics (I_F = Sorting Current, T_J = 25 $^{\circ}$ C)

ltem	Unit	Model	Rank	Min.	Тур.	Max.
Forward Voltage (V _F)	[V]	All model	-	32.0	35.5	38.0
Color Dandaring Inday (D.)			5	80	-	-
Color Rendering Index (Ra)	-	All model	7	90		
Beam Angle	0		-	_	115	-
	W / mA	LC010T	-	-	10 / 280	-
Nominal Power / Sorting Current		LC020T	-	-	20 / 560	-
		LC035T	-	-	35 / 980	_
		LC010T	-	-	3.32	-
Themal Resistance (Junction to Tc measurement point)	°C / W	LC020T	-	-	1.73	-
(sansasi to 15 insadaromont point)	•••	LC035T	=	-	0.95	-

Notes:

- 1) The COB is tested in pulsed condition at rated test current (10 ms pulse width) and rated temperature ($T_J = T_C = 25$ °C) Thermal Resistance is measured under conditions of $T_C = 85$ °C
- 2) Samsung maintains measurement tolerance of: forward voltage = ± 5 %, CRI = ± 3
- 3) Refer to the derating curve, '3. Typical Characteristics Graph' designed within the range
- 4) Minimum operating current (If_min): LC010T = 2mA, LC020T = 4mA, LC035T = 8mA.

c) Luminous Flux Characteristics (I_F = Sorting Current)

Model	CRI (Ra)	Nominal	Channel		Flux @ T _J = 25 °C (Im)
Model	Min.	CCT (K)	Chamei	Min.	Тур.	Max.
	80	2700	W	1131	1190	-
L C010T	00	6500	С	1285	1352	-
LC010T	90	2700	W	939	988	
	90	5000	С	1092	1149	
	80	2700	W	2237	2355	-
LC020T	00	6500	С	2543	2676	-
LCU201	90	2700	W	1858	1956	
	90	5000	С	2161	2275	
	80	2700	W	4185	4405	
LCOSET	60	6500	С	4756	5006	
LC035T	00	2700	W	3477	3660	-
	90	5000	С	4042	4255	-

Notes:

- 1) The COB is tested in pulsed operating condition at rated test current (10 ms pulse width) and rated temperature $(T_J = T_C = 25 \, ^{\circ}C)$.
- 2) Samsung maintains measurement tolerance of: Luminous flux = ± 7 %, CRI = ± 3

2. Product Code Information

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
S	Р	н	w	н	Α	н	D	N	н	2	5	Υ	z	w	Р	т	1

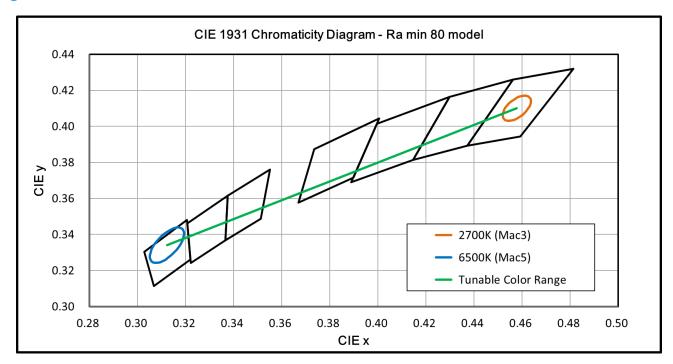
Digit	PKG Information	Code	Specification
1 2 3	Samsung Package High Power	SPH	
4 5	Color	WH	White
6	Product Version	Α	Tunable COB
7 8	Form Factor	HD	СОВ
9	Lens Type	N	No lens
10	Wattage or Model	C F H	LC010T LC020T LC035T
11	Internal Code	2	
12	CRI & Sorting Temperature	5 7	Min. 80 Min. 90
13 14	Forward Voltage (V)	YZ	32.0 ~ 38.0
15	CCT (K), Channel W	w	2700K
16	CCT (K), Channel C	P R	6500K 5000K
17 18	Luminous Flux (Lm)	T1	Tunable COB Gen.1 level

a) Binning Structure (If = Sorting Current, T_J = 25 °C)

CRI (R _a)	Model	Product Code	V_{F}	Color	Flux	Flu	x Range
Min.	Model	Product Code	Rank	Rank	Rank	(0	Þ _v , lm)
	LC010T	SPHWHAHDNC25YZWPT1	YZ	WP	T1 ·	WW	1131~
		SFIIWHAHDNO2312WF11	12	VVF	I I	CW	1285~
	1.0000T	SPHWHAHDNF25YZWPT1	V7	WD	Т4	WW	2237~
80	LC020T		YZ	WP	T1	CW	2543~
		SPHWHAHDNH25YZWPT1	YZ	WP	T4	WW	4185~
	LC035T				T1 ·	CW	4756~
	L 0040T		V/7	WD	T 4	WW	939~
	LC010T	SPHWHAHDNC27YZWRT1	YZ	WR	T1 ·	CW	1092~
90	LCOOOT	CDLIM/HALIDNIFOZYZIM/DT4	V7	WD	Τ4	WW	1858~
	LC020T	SPHWHAHDNF27YZWRT1	YZ	WR	T1 ·	CW	2161~
	I C025T		V7		Т1	WW	3477~
	LC035T	SPHWHAHDNH27YZWRT1	YZ	WR	T1	CW	4042~

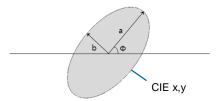
b) Chromaticity Region & Coordinates (If = Sorting Current, T_J = 25 °C)

① Ra min 80 model



	2700K										
х у Ө а В											
0.4578	0.4101	53.70	0.0081	0.0042							

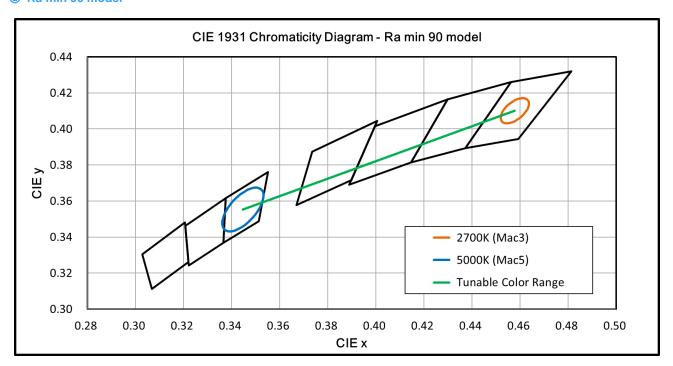
	6500K									
X	У	θ	а	b						
0.3123	0.3341	58.57	0.0112	0.0048						



Note:

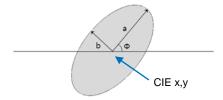
Samsung maintains measurement tolerance of: Cx, $Cy = \pm 0.005$

② Ra min 90 model



	2700K									
X	У	θ	а	В						
0.4578	0.4101	53.70	0.0081	0.0042						

		5000K		
Х	У	θ	а	b
0.3447	0.3553	59.62	0.0137	0.0059

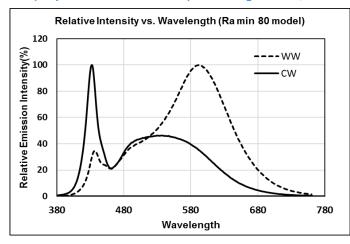


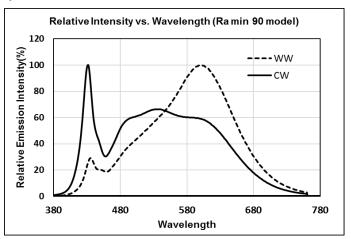
Note:

Samsung maintains measurement tolerance of: Cx, $Cy = \pm 0.005$

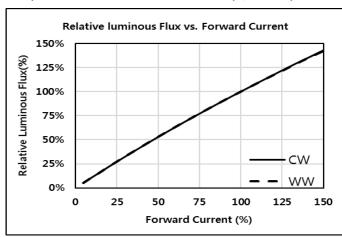
3. Typical Characteristics Graphs

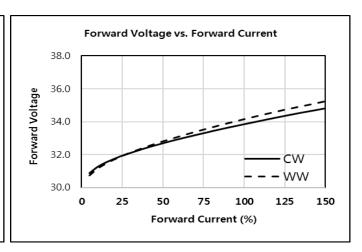
a) Spectrum Distribution (If = Sorting Current, T_J = 25 °C)



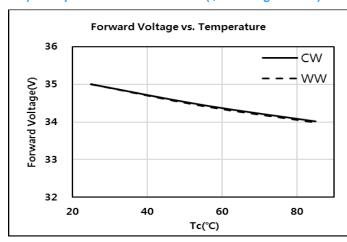


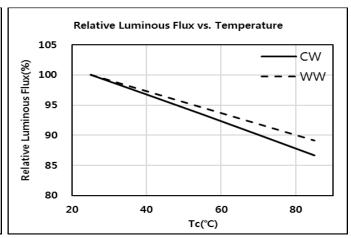
b) Forward Current Characteristics (T_J = 25 °C)



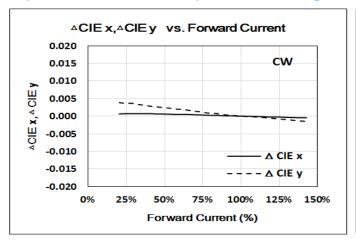


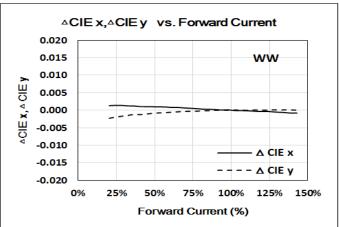
c) Temperature Characteristics (I_F =Sorting Current)





d) Color Shift Characteristics (T_J = 25 °C, I_F =Sorting Current)

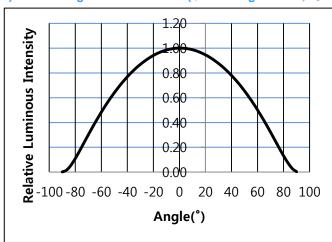




e) CCT, Color shift vs. Current ratio

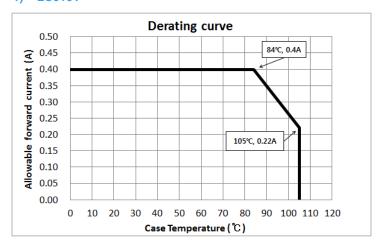
ССТ(К)		Ra min 8	30 model			Ra min 9	90 model		
CCT(K)	If_CW	If_WW	Cie x	Cie y	If_CW	If_WW	Cie x	Cie y	
6500	100%	0%	0.313	0.333					
5700	87%	13%	0.328	0.341					
5000	71%	29%	0.346	0.35	100%	0%	0.345	0.355	
4500	60%	40%	0.359	0.357	83%	17%	0.361	0.363	
4000	46%	54%	0.378	0.367	64%	36%	0.379	0.372	
3500	31%	69%	0.401	0.38	41%	59%	0.403	0.383	
3000	12%	88%	0.435	0.398	15%	85%	0.434	0.399	
2700	0%	100%	0.461	0.412	0%	100%	0.458	0.41	

f) Beam Angle Characteristics (I_F = Sorting Current, T_J = 25 $^{\circ}$ C)

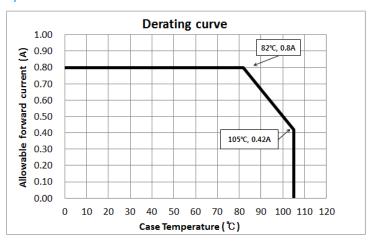


g) Derating Curve

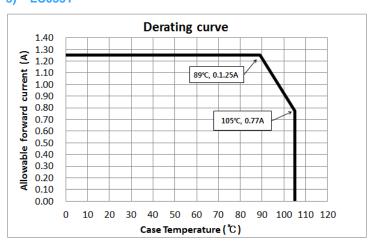
1) LC010T



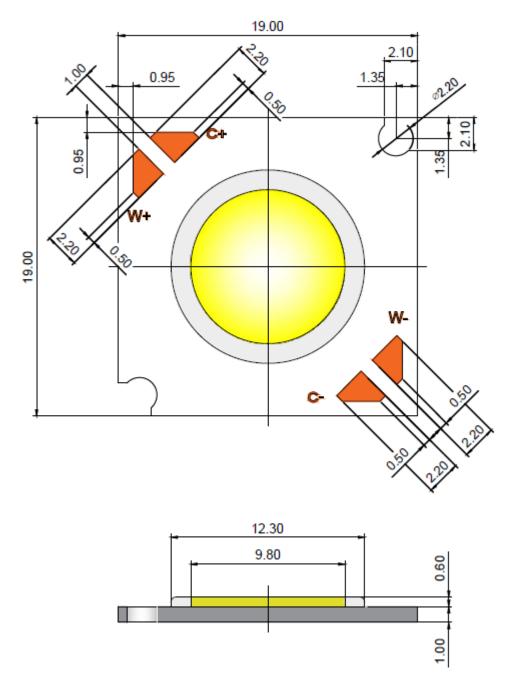
2) LC020T



3) LC035T

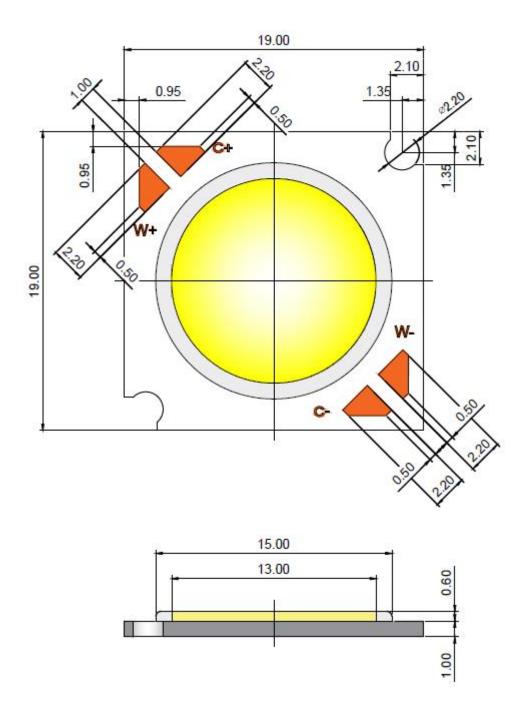


4. Outline Drawing & Dimension a) LC010T



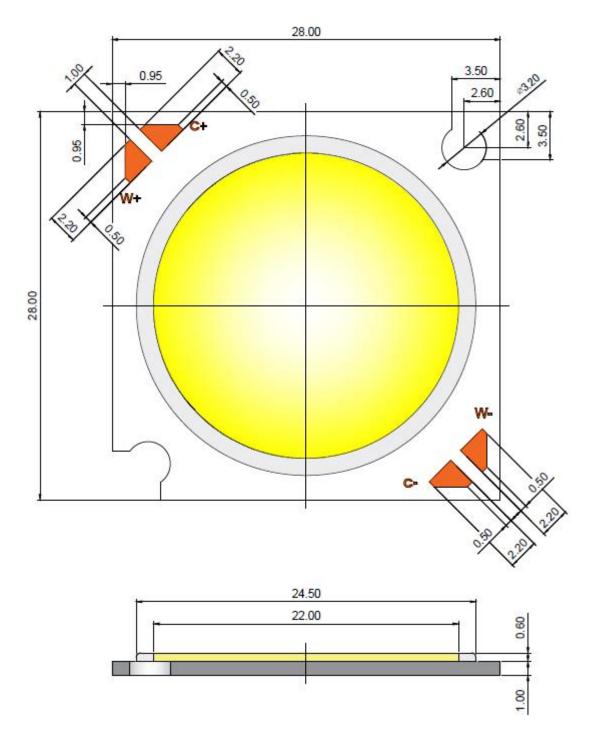
Unit: mm Tolerance (Lateral): \pm 0.3 mm Tolerance (Height): \pm 0.2 mm

b) LC020T



Unit: mm Tolerance (Lateral): \pm 0.3 mm Tolerance (Height): \pm 0.2 mm

c) LC035T



Unit: mm Tolerance (Lateral): ± 0.3 mm Tolerance (Height): ± 0.2 mm

5. Reliability Test Items & Conditions

a) Test Items

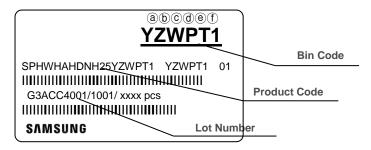
Test Item	Test Condition	Test Hour / Cycle
High Temperature Operating Life Test	85 °C, DC Derating, I _F	1000 h
Wet High Temperature Operating Life Test	60 °C, 90 % RH,, DC Derating, I _F	1000 h
Low Temperature Operating Life Test	-40 °C, DC,Derating I _F	1000 h
High Temperature Storage	120 °C	1000 h
Low Temperature Storage	-40 °C	1000 h
Wet High Temperature Storage	60 ℃, 90% RH	1000h
Powered Temperature Cycle	-40 °C/ 85 °C each 10 min, 20 min transfer power on/off each 5 min, DC Derating, $I_{\rm F}$	100 cycles
Temperature Cycling	-45 °C / 15min ~ 125 °C / 15min Temperature change within 5min	500 cycles
ESD (HBM)	R_1 : 10 M Ω R_2 : 1.5 k Ω C: 100 pF V : ± 2 k V	5 times
Vibration Test	20~ 80 Hz (displacement: 0.06 inch, max. 20 g) 80 ~ 2 kHz (max. 20 g) min. frequency ↔max. frequency 4 min transfer	4 times
Mechanical Shock Test	1500g, 0.5 ms each of the 6 surfaces (3 axis x 2 sides)	5 times

b) Criteria for Judging the Damage

ltem	Symbol	Test Condition	Lir	Limit	
	Зуппоп	(T _c = 25 °C)	Min.	Max.	
Forward Voltage	V_{F}	I _F = Sorting Current	L.S.L. * 0.9	U.S.L. * 1.1	
Luminous Flux	Ф	I _F = Sorting Current	L.S.L * 0.7	U.S.L * 1.3	

6. Label Structure

a) Label Structure



Note: Denoted bincode and product code above is only an example (see description on page 5)

Bin Code:

(a) (refer to page 3)

©d: Chromaticity bin (refer to page 7)

(e) f): Luminous Flux bin (refer to page 6)

b) Lot Number

The lot number is composed of the following characters:

SAMSUNG

① 3456789 / 1abc / xxxx pcs

1 : Production site (S: Giheung, Korea, G: Tianjin, China)

② : 3(LED)

3 : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample)

④ : Year (C: 2018, D: 2019, E: 2020...)

(5) : Month (1~9, A, B, C)

6789 : Day (1~9, A, B~V)

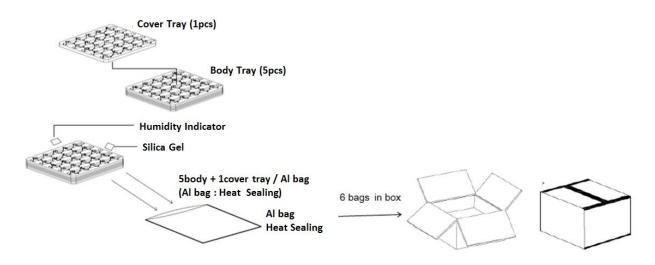
(a) b) c : Product serial number (001 ~ 999)

7. Packing Structure

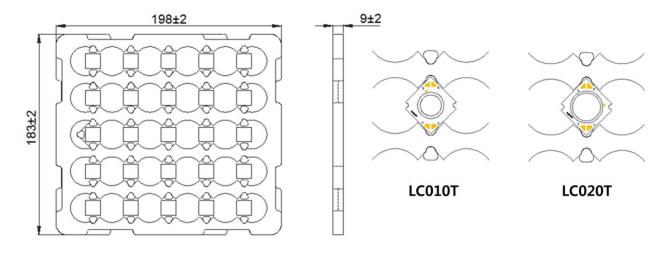
Model: LC010T, LC020T

	Max. quantity	Dimension(mm)			
Packing material	in pcs of COB	Length	Width	Height	Tolerance
Tray	25	198	183	9	2
AL Bag	125 (5 trays)	300	240	-	1
Outer Box (Small)	750 (6 bags)	248	225	187	5

a) Packing Structure



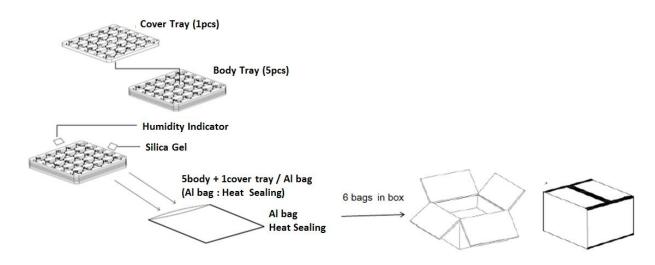
b) Tray



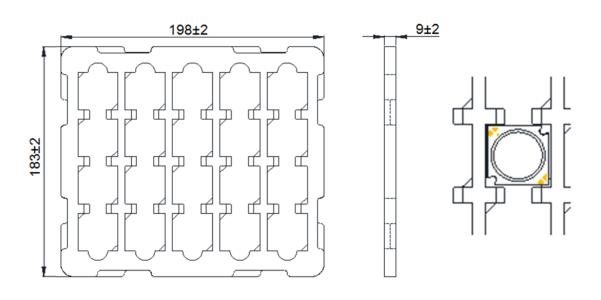
Model: LC035T

	Max. quantity	Dimension(mm)			
Packing material	in pcs of COB	Length	Width	Height	Tolerance
Tray	20	198	183	9	2
AL Bag	100 (5 trays)	300	240	-	1
Outer Box (Small)	600 (6 bags)	248	225	187	5

a) Packing Structure

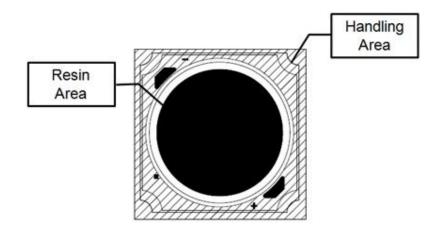


b) Tray



8. Precautions in Handling & Use

- This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA
 is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the
 device.
- 2) LEDs must be stored in a clean environment. If the LEDs are to be stored for three months or more after being shipped from Samsung, they should be packed with a nitrogen-filled container (shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH).
- 3) After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 - a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 - b. Stored at <10 % RH
- 4) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- 5) Devices require baking before mounting, if humidity card reading is >60 % at $23 \pm 5 \degree$ C.
- 6) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 7) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 8) The thermal management is one of the most critical factors for the LED lighting system. Especially the LED junction temperature should not exceed the absolute maximum rating while operation of LED lighting system.
 - For more information, please refer to Application Note 'Mechanical & Thermal Guide for COB'.
- 9) In case of driving LEDs around the extremely low current level, chips might exhibit different brightness due to the variation in I-V characteristics of each one. This is normal and does not adversely affect the performance of product.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.
- 11) The resin area is very sensitive, please do not handle, press, touch, rub, clean, or pick by with tweezers on it. Instead, please pick at the handling area as indicated below.



Legal and additional information.

About Samsung Electronics Co., Ltd.

Samsung Electronics Co., Ltd. inspires the world and shapes the future with transformative ideas and technologies, redefining the worlds of TVs, smartphones, wearable devices, tablets, cameras, digital appliances, printers, medical equipment, network systems and semiconductors.

We are also leading in the Internet of Things space through, among others, our Digital Health and Smart Home initiatives. We employ 307,000 people across 84 countries. To discover more, please visit our official website at www.samsung.com and our official blog at global.samsungtomorrow.com.

Copyright © 2015 Samsung Electronics Co., Ltd. All rights reserved. Samsung is a registered trademark of Samsung Electronics Co., Ltd. Specifications and designs are subject to change without notice. Non-metric

weights and measurements are approximate. All data were deemed correct

at time of creation. Samsung is not liable for errors or omissions. All brand.

product, service names and logos are trademarks and/or registered trademarks

of their respective owners and are hereby recognized and acknowledged.

Samsung Electronics Co., Ltd. 95, Samsung 2-ro Giheung-gu Yongin-si, Gyeonggi-do, 446-711 KOREA

www.samsungled.com

